2SK3268

Silicon N-channel power MOSFET

■ Features

- Avalanche energy capability guaranteed
- High-speed switching
- Low ON resistance Ron
- No secondary breakdown
- Low-voltage drive
- High electrostatic energy capability

Applications

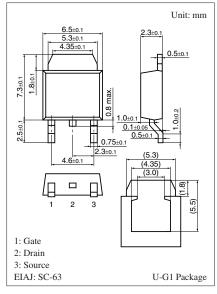
- Non-contact relay
- Solenoid drive
- Motor drive
- Control equipment
- Switching mode regulator

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Drain-source surrender voltage	V _{DSS}	100	V	
Gate-source surrender voltage	V _{GSS}	±20	V	
Drain current	I_D	±15	A	
Peak drain current	I_{DP}	±60	A	
Avalanche energy capability *	EAS	22.5	mJ	
Power dissipation	P_{D}	20	W	
$T_a = 25^{\circ}C$		1		
Channel temperature	T _{ch}	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

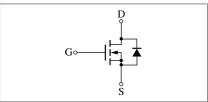
Note) *: L = 0.2 mH, I_L = 15 A, 1 pulse ■ Electrical Characteristics T_C = 25°C ± 3°C		s Š					
Parameter	Symbol	Conditions		Min	Тур	Max	Unit
Drain-source surrender voltage		$I_D = 1 \text{ mA}, V_{GS} = 0$		100	тур	IVIAX	V
Drain-source cutoff current	V _{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0$	1	100		10	μA
Gate-source cutoff current	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{GS} = 0$				±1	μΑ
Gate threshold voltage	V _{th}	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$		2.0		4.0	V
Forward transfer admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, I_D = 12 \text{ A}$		6	11		S
Drain-source ON resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$			70	100	mΩ
Diode forward voltage	V_{DF}	$I_{DR} = 15 \text{ A}, V_{GS} = 0$				-1.4	V
Short-circuit forward transfer capacitance (Common source)	C _{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ M}$	Hz		960		pF
Short-circuit output capacitance (Common source)	C _{oss}				285		pF
Reverse transfer capacitance (Common source)	C _{rss}				85		pF
Turn-on delay time	t _{d(on)}	$V_{DD} = 30 \text{ V}, I_D = 12 \text{ A}, R_L = 12 \text{ A}$	2.5 Ω		15		ns
Rise time	t _r	$V_{GS} = 10 \text{ V}$			10		ns
Fall time	$t_{\rm f}$				35		ns
Turn-off delay time	t _{d(off)}				65		ns
Thermal resistance (ch-c)	R _{th(ch-c)}					6.25	°C/W
Thermal resistance (ch-a)	R _{th(ch-a)}					125	°C/W

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



Marking Symbol: K3268

Internal Connection



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